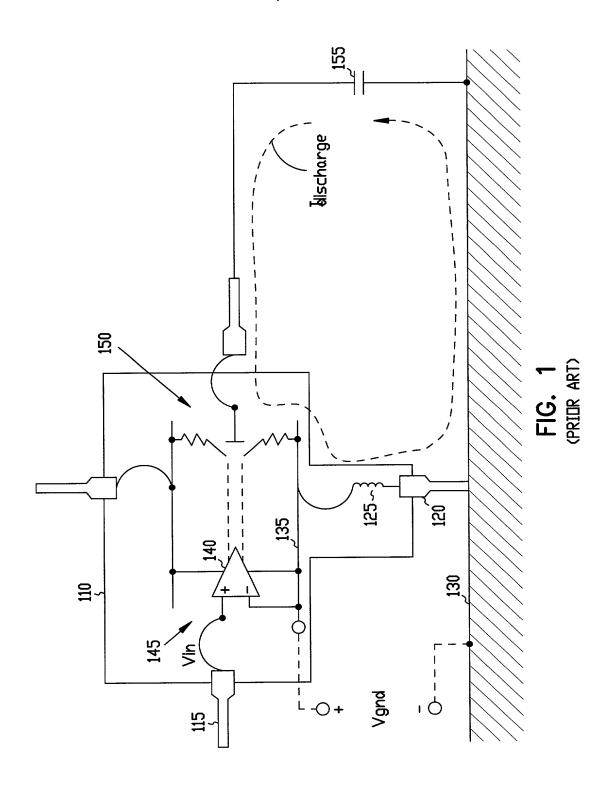
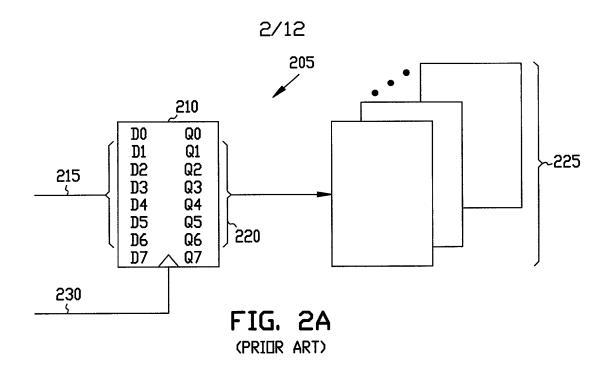
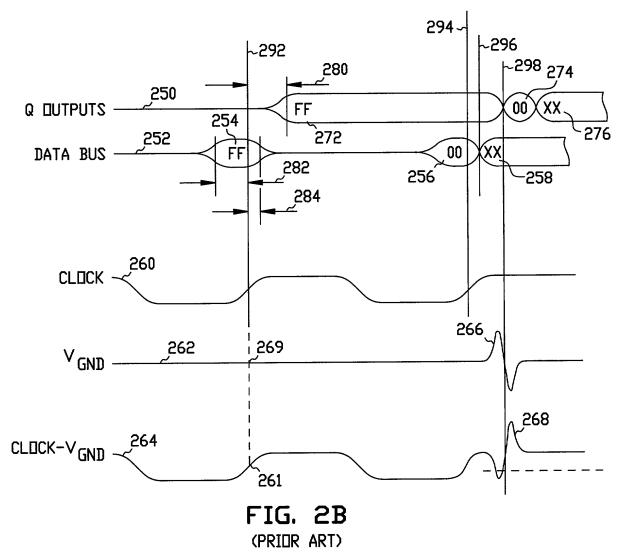
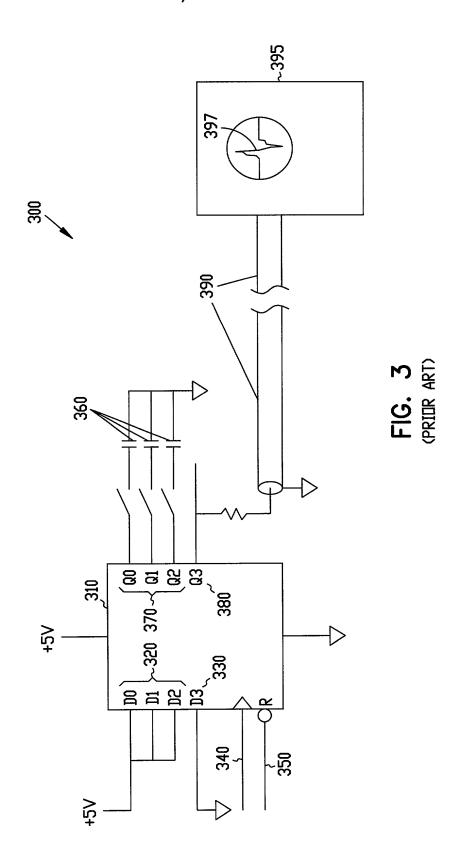
1/12







3/12



4/12

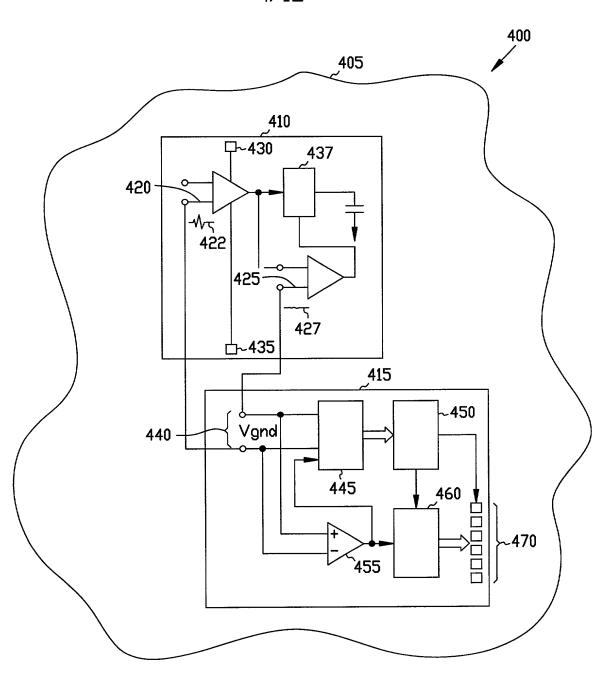


FIG. 4

5/12

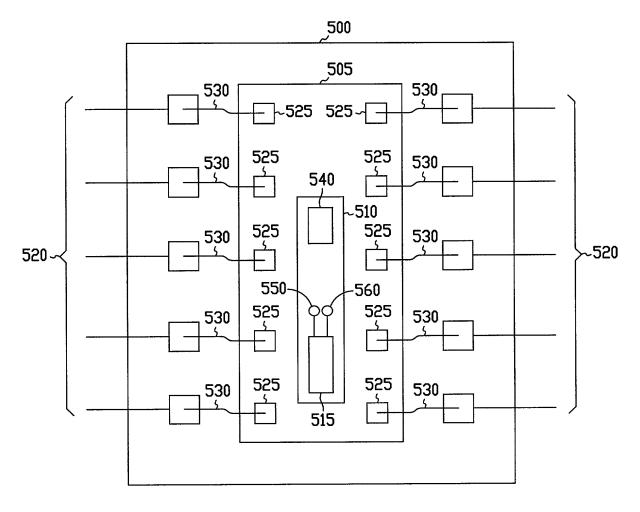
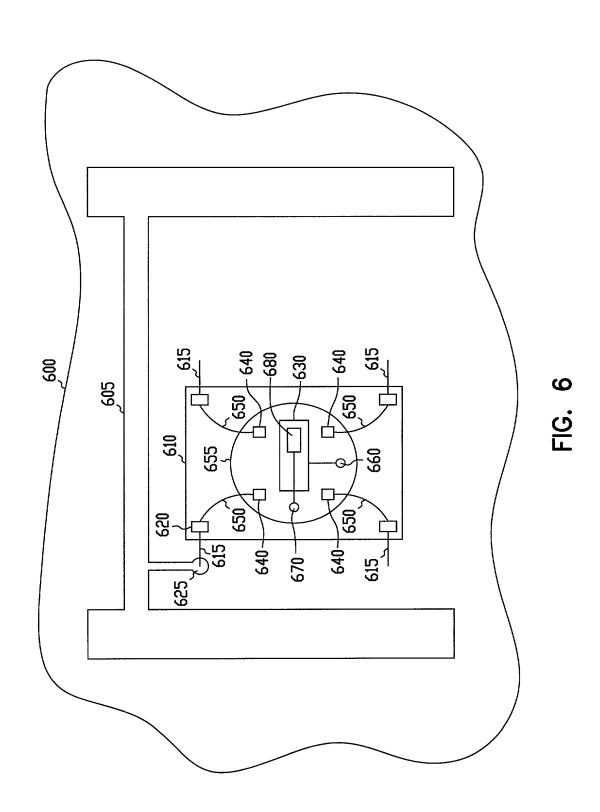
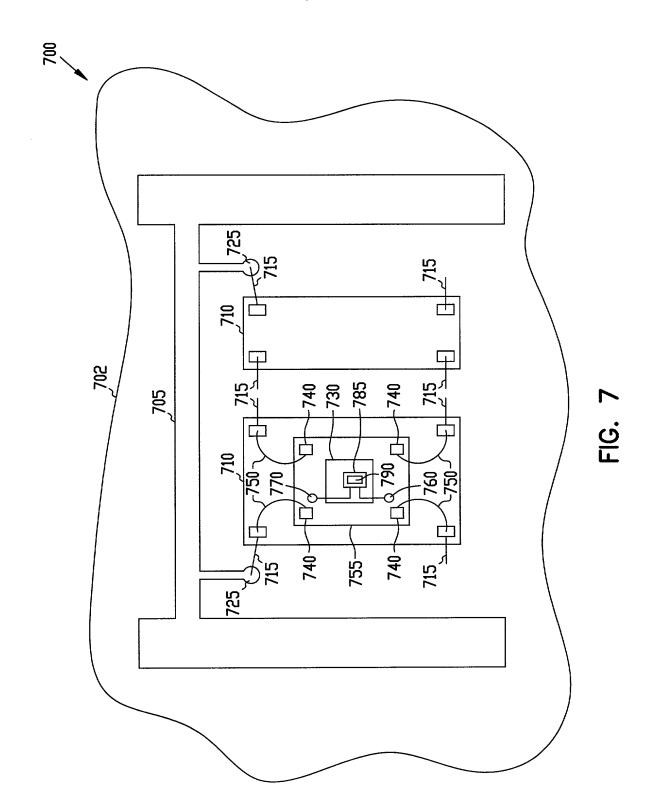


FIG. 5

6/12



7/12



8/12

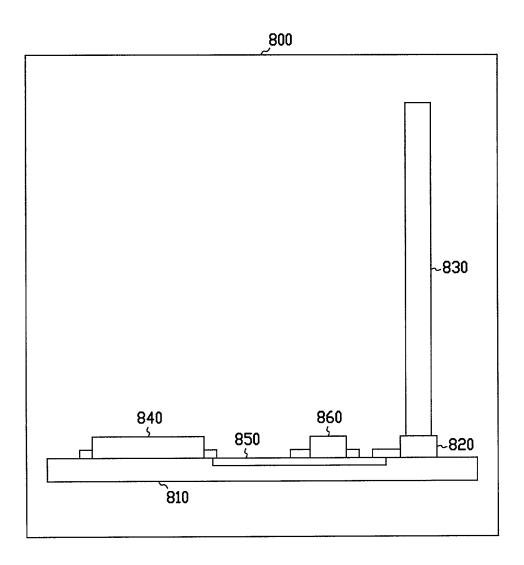


FIG. 8

9/12

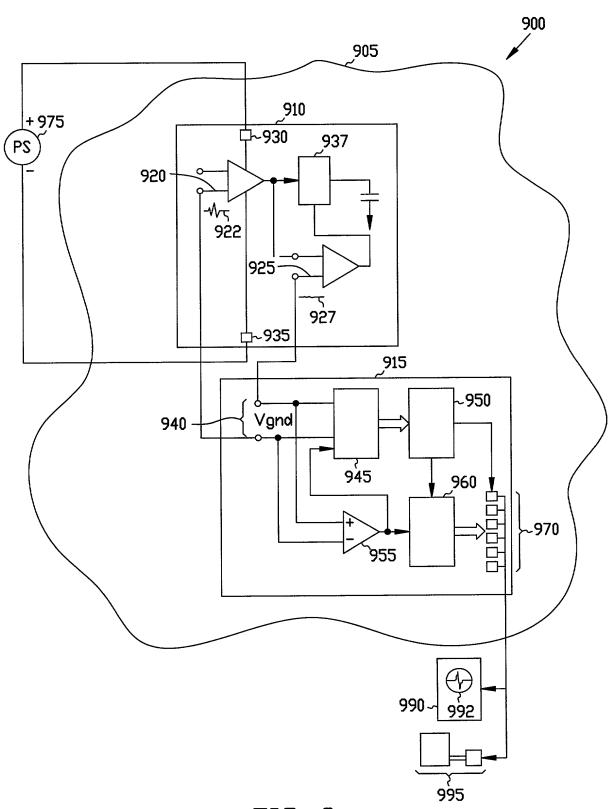
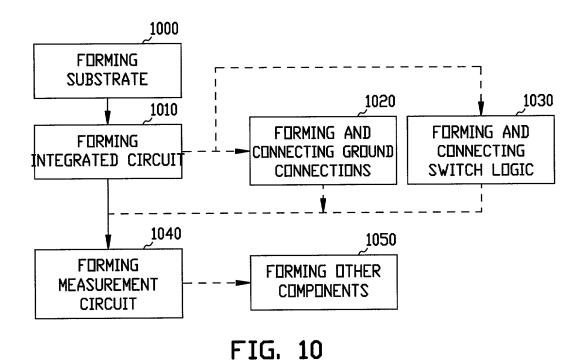


FIG. 9

10/12



1100 FORMING SUBSTRATE 1110 FORMING **LEADS** 1120 1130 1140 CONNECT LEADS TO CONNECT DOMAINS \$UBSTRATE INCLUDING FORMING OTHER AND GROUND INTEGRATED CIRCUIT **COMPONENTS** WITH MEASUREMENT **CONNECTIONS**

FIG. 11

CIRCUIT

11/12

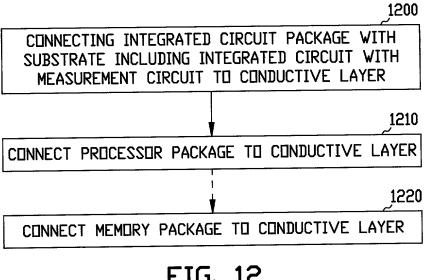


FIG. 12

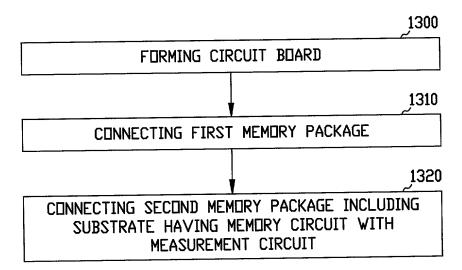
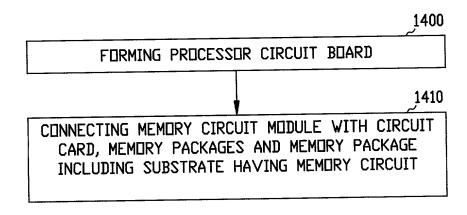


FIG. 13



12/12

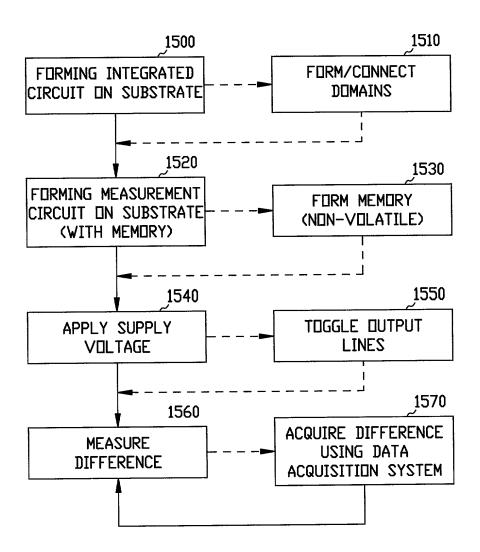


FIG. 15